







CD74HC4051-Q1 SCLS552B - DECEMBER 2003 - REVISED APRIL 2024

CD74HC4051-Q1 Automotive Analog Multiplexer or Demultiplexer

1 Features

- Qualified for automotive applications
- Wide analog input voltage range of ± 5V maximum
- Low ON resistance:

 - 70Ω typical (V _{CC} V _{EE} = 4.5V) 40Ω typical (V _{CC} V _{EE} = 9V)
- Low crosstalk between switches
- Fast switching and propagation speeds
- Break-before-make switching
- Operation control voltage = 2V to 6V
- Switch voltage = 0V to 10V
- High noise immunity N $_{\rm IL}$ = 30%, N $_{\rm IH}$ = 30% of V_{CC} , $V_{CC} = 5V$

2 Applications

- Digital radio
- Signal gating
- **Factory automation**
- **Televisions**
- **Appliances**
- Programmable logic circuits
- **Sensors**

3 Description

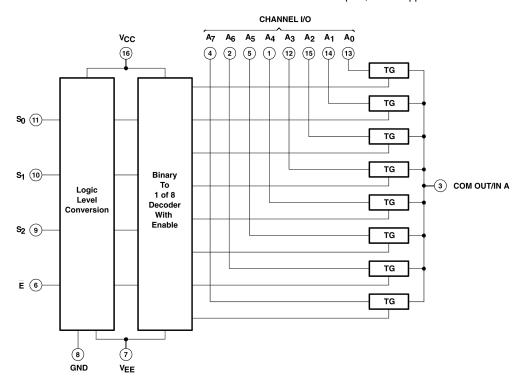
This device is a digitally controlled analog switch that utilizes silicon-gate CMOS technology to achieve operating speeds similar to LSTTL, with the low power consumption of standard CMOS integrated circuits.

This analog multiplexer/demultiplexer controls analog voltages that may vary across the voltage supply range (for example, V_{CC} to V_{EE}). These bidirectional switches allow any analog input to be used as an output and vice versa. The switches have low ON resistance and low OFF leakages. In addition, the device has an enable control (\overline{E}) that, when high, disables all switches to their OFF state.

Package Information

PART NUMBER	PACKAGE ⁽¹⁾	PACKAGE SIZE ⁽²⁾
CD74HC4051-Q1	PW (TSSOP, 16)	5mm × 6.4mm
CD1411C4031-Q1	D (SOIC, 16)	9.9mm × 3.9mm

- For more information see, Section 10
- The package size (length × width) is a nominal value and includes pins, where applicable.



Logic Diagram (Positive Logic)



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4 Pin Configuration and Functions

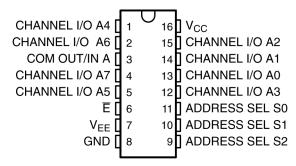


Figure 4-1. PW, D Package, 16-Pin TSSOP, SOIC (Top View)

Table 4-1. Function Table

	ON CHANNEL(S)			
E	S ₂	S ₁	S ₀	
L	L	L	L	A0
L	L	L	Н	A1
L	L	Н	L	A2
L	L	Н	Н	A3
L	Н	L	L	A4
L	Н	L	Н	A5
L	Н	Н	L	A6
L	Н	Н	Н	A7
Н	Х	Х	Х	None

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5 Specifications

5.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) (1)

			MIN	MAX	UNIT
V _{CC} - V _{EE} (see ⁽²⁾)	Supply voltage range		-0.5	10.5	V
V _{CC}	Supply voltage range		-0.5	7	V
V _{EE}	Supply voltage range		+0.5	-7	V
I_{IK} (V _I < -0.5V or V _I > V _{CC} + 0.5V)	Input clamp current			±20	mA
I_{OK} (V _O < V _{EE} - 0.5V or V _O > V _{CC} + 0.5V)	Output clamp current			±20	mA
$(V_I > V_{EE} - 0.5V \text{ or } V_I < V_{CC} + 0.5V)$	Switch current			±25	mA
	Continuous current through V _{CC} or GND			±50	mA
I _{EE}	V _{EE} current			-20	mA
		D		91.6	°C/W
R _{eJA}	Package thermal impedance	package		31.0	O/ VV
INGJA	ackage thermal impedance	PW		116.5	°C/W
		package		110.5	C/VV
TJ	Maximum junction temperature			150	°C
Lead temperature (during soldering):			2 1/16 ± 1,59 ± 0,79 case for 10	300	°C
T _{stg}	Storage temperature range		-65	150	°C

⁽¹⁾ Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) All voltages referenced to GND unless otherwise specified.

5.2 Recommended Operating Conditions

(see (1))

			MIN	MAX	UNIT
V _{CC}	Supply voltage (see ⁽²⁾)	Supply voltage (see ⁽²⁾)		6	V
	Supply voltage, V _{CC} - V _{EE} (see Figu	ure 5-1)	2	10	V
V _{EE}	Supply voltage, (see (2) and Figure	5-2)	0	-6	V
	√ _{IH} High-level input voltage	V _{CC} = 2V	1.5		
V_{IH}		V _{CC} = 4.5V	3.15		V
		V _{CC} = 6V	4.2		
		V _{CC} = 2V		0.5	
V_{IL}	Low-level input voltage	V _{CC} = 4.5V		1.35	V
		V _{CC} = 6V		1.8	
VI	Input control voltage	-	0	V _{CC}	V
V _{IS}	Analog switch I/O voltage		V _{EE}	V _{CC}	V
		V _{CC} = 2V	0	1000	
t _t	Input transition (rise and fall) time	V _{CC} = 4.5V	0	500	ns
		V _{CC} = 6V	0	400	
T _A	Operating free-air temperature	•	-40	125	°C

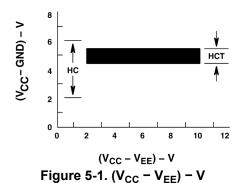
All unused inputs of the device must be held at V_{CC} or GND for proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

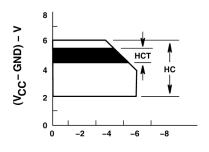
⁽²⁾ In certain applications, the external load resistor current may include both V_{CC} and signal-line components. To avoid drawing V_{CC} current when switch current flows into the transmission gate inputs, the voltage drop across the bidirectional switch must not exceed



0.6V (calculated from r_{on} values shown in electrical characteristics table). No V_{CC} current flows through R_L if the switch current flows into the COM OUT/IN A terminal.

5.3 Recommended Operating Area as a Function of Supply Voltages





(V_{EE} - GND) - V Figure 5-2. (V_{EE} - GND) - V

5.4 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER	TEST CONDITIONS		V _{EE}	V _{cc}	-	T _A = 25 °C		T _A = -40 °C TO 125°C	UNIT
TANAMETER	1201 CON	Difficito	V EE	▼CC	MIN	TYP	MAX	MIN X	Oitii
			0V	4.5V		70	160	240	
		$V_{IS} = V_{CC}$ or	0V	6V		60	140	210	
r	$I_O = 1 \text{ mA}, V_I = V_{IH}$ or V_{IL} , See Figure	V _{EE}	-4.5 V	4.5V		40	120	180	Ω
r _{on}	5-3		0V	4.5V		90	180	270	
		$V_{IS} = V_{CC}$ to	0V	6V		80	160	240	
		V _{EE}	-4.5 V	4.5V		45	130	195	
				4.5V		10			
Δr_{on}	Between any two channels		0V	6V		8.5			Ω
on	2000 a,	serveen any two onannois		4.5V		5			
	For switch OFF:		0V	6V			±0.2	±2	
I _{IZ}	When $V_{IS} = V_{CC}$, $V_{OS} = V_{EE}$; When $V_{IS} = V_{EE}$, $V_{OS} = V_{CC}$ For switch ON: All applicable combinations of V_{IS} and V_{OS} voltage levels, $V_{I} = V_{IH}$ or V_{IL}		-5V	5V			±0.4	±4	μА
I _{IL}	V _I = V _{CC} or GND		0V	6V			±0.1	±1	μΑ
laa	I _O = 0, V _I = V _{CC} or	When V _{IS} = V _{EE} , V _{OS} = V _{CC}	0V	6V			12	160	μA
Icc	GND	When V _{IS} = V _{CC} , V _{OS} = V _{EE}	-5V	5V			32	320	μΛ



5.5 Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 6-5)

PARAMETER	FROM	то	LOAD	V _{EE}	V _{cc}		T _A = 25°C	,	T _A = -40 °C TO 125°C	UNI																
FARAMETER	(INPUT) (OUTPUT) CAPACITANCE	▼cc	MIN	TYP	MAX	MIN MA	Т																			
			C _L = 15pF		5V		4			ns																
					2V			60	90																	
t_{pd}	IN	OUT		0V	4.5V			12	18																	
βū			C _L = 50pF		6V			10	15	ns																
				-4.5 V	4.5V			8	12																	
		DDRESS EL or Ē OUT	C _L = 15pF		5V		19																			
				C _L = 50pF			C _L = 50pF	C _L = 50pF	$C_L = 50 pF$	C _L = 50pF		2V			325	490										
t _{en}	ADDRESS										C _L = 50pF	C _L = 50pF	0V	4.5V			45	68	ns							
	SEL or E		C _L = 50pF										$C_L = 50pF$	$C_L = 50pF$	$C_L = 50pF$	$C_L = 50pF$	$C_L = 50pF$	$C_L = 50pF$	$C_L = 50pF$	$C_L = 50pF$	C _L = 50pF	$C_L = 50pF$	$C_L = 50pF$			
				-4.5 V	4.5V			32	48																	
			C _L = 15pF		5V		27																			
		C _L = 50pF	OUT $C_L = 50 pF$		C _L = 50pF	C _L = 50pF	OUT $C_L = 50 pF$	T C _L = 50pF	C _L = 50pF	C _L = 50pF		2V			250	400										
t _{dis}	ADDRESS SEL or E										C _L = 50pF	C _L = 50pF	C _L = 50pF	JT	C _L = 50pF	T	0V	4.5V			50	68	ns			
	SELUIE			$C_L = 50pF$													$C_L = 50pF$	C _L = 50pF	C _L = 50pF	$C_L = 50pF$	C _L = 50pF		6V			
				,								-4.5 V	4.5V			44	55									
Cı	Control		C _L = 50pF					10	10	pF																

5.6 Operating Characteristics

 V_{CC} = 5V, T_A = 25°C, Input t_r , t_f = 6 ns

	PARAMETER			
C _{pd}	Power dissipation capacitance (see ⁽¹⁾)	50	pF	

- (1) C_{pd} is used to determine the dynamic power consumption, per package.
 - $P_D = C_{pd} V_{CC}^2 f_I + \Sigma (C_L + C_S) V_{CC}^2 f_O$
 - f_O = output frequency
 - f_I = input frequency
 - C_L = output load capacitance
 - C_S = switch capacitance
 - V_{CC} = supply voltage

5.7 Analog Channel Characteristics

 $T_A = 25^{\circ}C$

PARAMETER		TEST CONDITIONS	V _{EE}	V _{CC}	MIN	TYP N	IA UNI
C _I	Switch input capacitance					5	pF
C _{COM}	Common output capacitance					25	pF
f _{max}	Minimum switch frequency response at −3 dB	See Figure 6-1 and Figure	-2.25V	2.25V		145	— MHz
		5-4, and ⁽¹⁾ and ⁽²⁾	-4.5V	4.5V		180	IVII IZ



5.7 Analog Channel Characteristics (continued)

 $T_A = 25^{\circ}C$

PARAMETER		TEST CONDITIONS	V _{EE}	V _{cc}	MIN TYP	MA X	UNI T
THD	Sine-wave distortion	See Figure 6-2	-2.25V	2.25V	0.03 5		%
			-4.5V	4.5V	0.01 8		70
0	Switch OFF signal feed through	See Figure 6-4 and Figure	-2.25V	2.25V	-73		dB
O _{ISO}		5-5, and ⁽²⁾ and ⁽³⁾	-4.5V	4.5V	-75		ub

- (1) Adjust input voltage to obtain 0 dBm at V_{OS} for f_{IN} = 1MHz.
- (2) V_{IS} is centered at (V_{CC} V_{EE})/2.
- (3) Adjust input for 0 dBm.

5.8 Typical Characteristics

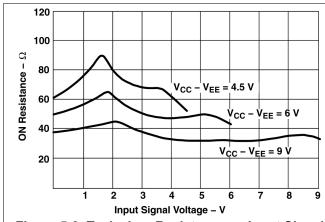


Figure 5-3. Typical on Resistance vs Input Signal Voltage

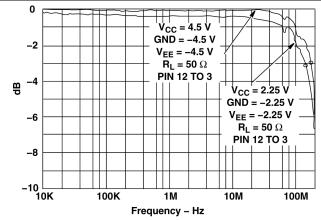


Figure 5-4. Channel on Bandwidth

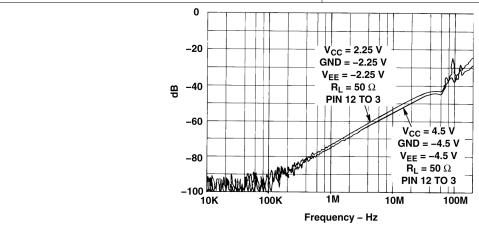


Figure 5-5. Channel off Feed-through



6 Parameter Measurement Information

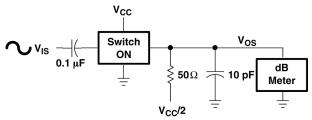


Figure 6-1. Frequency-Response Test Circuit

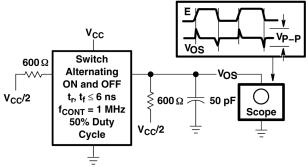
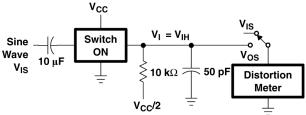


Figure 6-3. Control to Switch Feed-through Noise Test Circuit



 $f_{IS} = 1 \text{ kHz to } 10 \text{ kHz}$

Figure 6-2. Sine-Wave Distortion Test Circuit

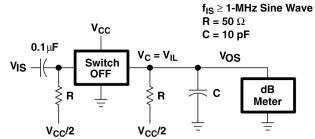
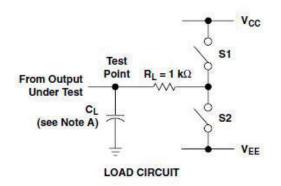
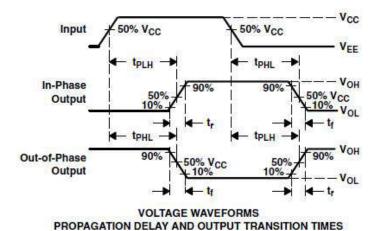


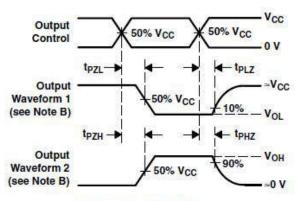
Figure 6-4. Switch off Signal Feed-through Test Circuit





PARA	METER	S1	S2
	tpzH	Open	Closed
ten	tpzL	Closed	Open
tara	t _{PHZ}	Open	Closed
tdis	tpLZ	Closed	Open
tpd		Open	Open





VOLTAGE WAVEFORMS
OUTPUT ENABLE AND DISABLE TIMES

- A. C_L includes probe and test-fixture capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR \leq 1MHz, $Z_O = 50\Omega$, $t_r = 6$ ns.
- D. For clock inputs, f_{max} is measured with the input duty cycle at 50%.
- E. The outputs are measured one at a time with one input transition per measurement.
- F. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
- G. t_{PZL} and t_{PZH} are the same as t_{en}.
- H. t_{PLH} and t_{PHL} are the same as t_{pd} .

Figure 6-5. Load Circuit and Voltage Waveforms

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7 Detailed Description

7.1 Functional Block Diagram

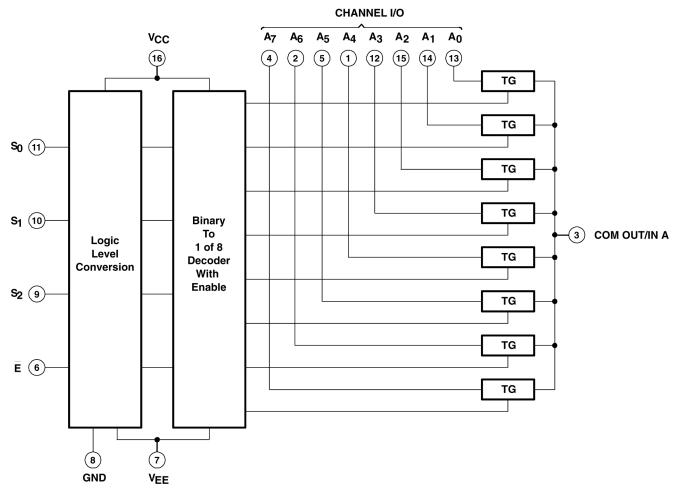


Figure 7-1. Logic Diagram (Positive Logic)

7.2 Device Functional Modes

Table 7-1. Function Table

	IN	IPUTS	ON CHANNEL(S)	
Ē	S ₂	S ₁	S ₀	ON CHANNEL(3)
L	L	L	L	A0
L	L	L	Н	A1
L	L	Н	L	A2
L	L	Н	Н	A3
L	Н	L	L	A4
L	Н	L	Н	A5
L	Н	Н	L	A6
L	Н	Н	Н	A7
Н	X	X	X	None



8 Device and Documentation Support

TI offers an extensive line of development tools. Tools and software to evaluate the performance of the device, generate code, and develop solutions are listed below.

8.1 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Notifications* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

8.2 Support Resources

TI E2E[™] support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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8.4 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

8.5 Glossary

TI Glossary

This glossary lists and explains terms, acronyms, and definitions.

9 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision A (April 2008) to Revision B (April 2024)		Page
•	Updated the numbering format for tables, figures, and cross-references throughout the document	1
•	Changed M (SOIC, 16) to D (SOIC, 16) to accurately reflect the package drawing	1
•	Changed the package thermal impedance for the D package from: 73°C/W to: 91.6°C/W	3
•	Changed the package thermal impedance for the PW package from: 108°C/W to: 116.5°C/W	3
•	Changed I_{CC} MAX from: $8\mu A$ to: $12\mu A$ when $V_{IS} = V_{EE}$, $V_{OS} = V_{CC}$ at a TA = 25°C	4
•	Changed I_{CC} MAX from: 16 μ A to: 32 μ A when $V_{IS} = V_{CC}$, $V_{OS} = V_{EE}$ at a TA = 25°C	4
•	Changed t_{en} MAX from: 225ns to: 325ns when C_L = 50pF at a TA = 25°C and from: 340ns to: 490ns when t_{en} when t_{en} to: 490ns when t_{en} to:	nen C _L
	= 50pF at a TA = -40°C to 125°C	<mark>5</mark>
•	Changed t_{dis} TYP from: 19ns to: 27ns when C_L = 15pF at a TA = 25°C	5
•	Changed t_{dis} MAX from: 225ns to: 250ns when C_L = 50pF, V_{EE} = 0V, and V_{CC} = 2V at a TA = 25°C, and	l from:
	340ns to: 400ns at a TA = -40°C to 125°C	5
•	Changed t_{dis} MAX from: 45ns to: 50ns when $C_L = 50pF$, $V_{EE} = 0V$, and $V_{CC} = 4.5V$ at a TA = 25°C	5
•	Changed t_{dis} MAX from: 38ns to: 44ns when $C_L = 50pF$, $V_{EE} = 0V$, and $V_{CC} = 6V$ at a TA = 25°C	5
•	Changed t_{dis} MAX from: 32ns to: 44ns when C_L = 50pF, V_{EE} = -4.5V, and V_{CC} = 4.5V at a TA = 25°C, a	nd
	from: 48ns to: 55ns at a TA = -40°C to 125°C	5
•	Removed the TBD E or ADDRESS SEL to switch feed-through noise parameter	5

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10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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